

- **Description:**

High current density due to double mesa technology;  
BTA100 Series triacs is suitable for general purpose AC switching.

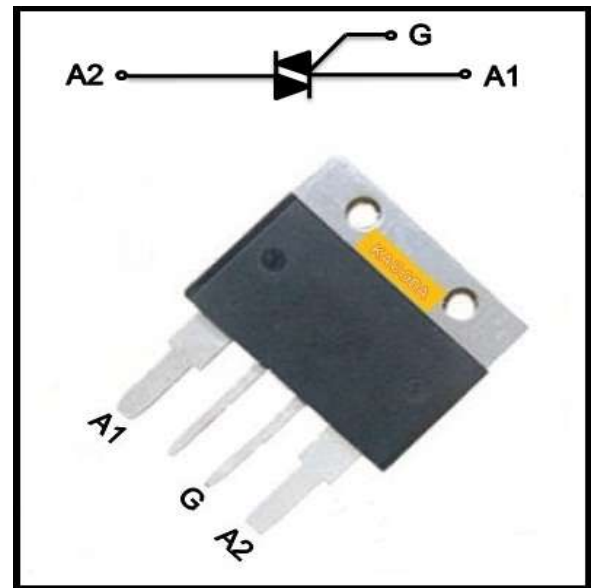
- **Applications:**

they can be used as an ON/OFF function in applications such as static relays, heating regulation, induction motor starting circuits... or for phase control operation light dimmers, motor speed controllers

- **Features:**

BTA100 series are insulated design  
Blocking voltage to 800/1000/12000/1600V  
On-state RMS current to 100A  
Non-repetitive peak on-state current to 1000A

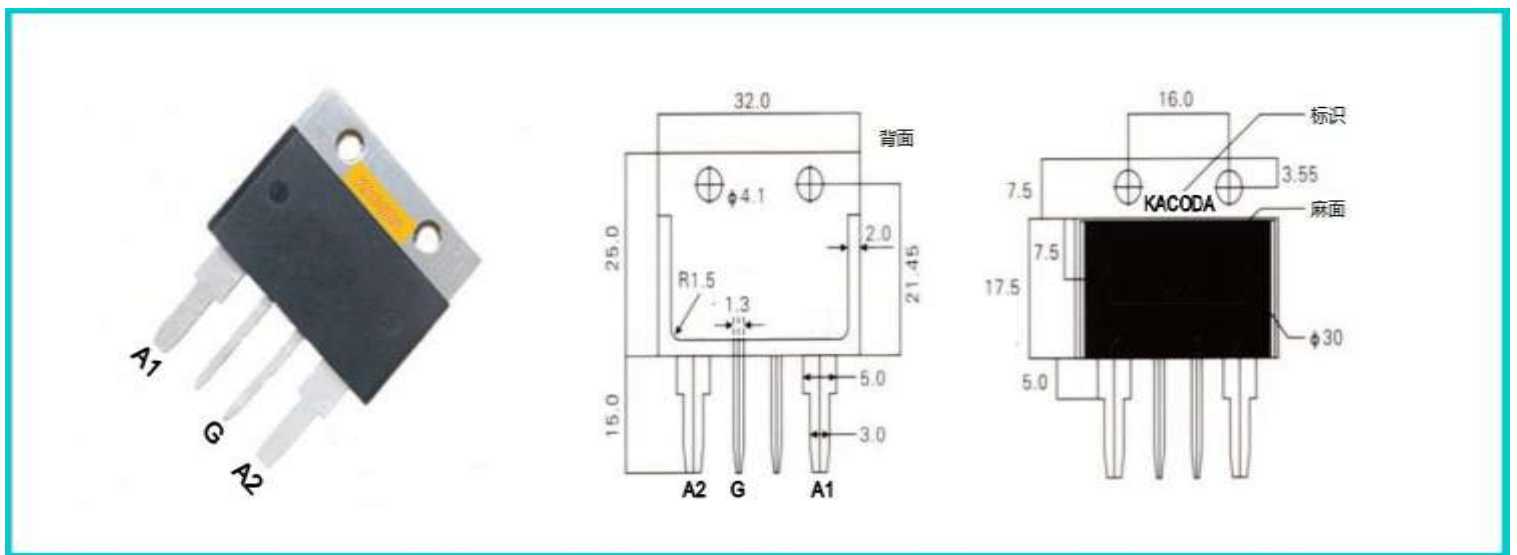
- **Absolute Maximum Ratings**



| Symbol       | Parameter                            | Conditions  | Min | Max  | Unit                   |
|--------------|--------------------------------------|---|-----|------|------------------------|
| $V_{DRM}$    | Repetitive peak off-state voltage    | $T_J=25^\circ\text{C}$  | 800 | 1600 | V                      |
| $V_{RRM}$    | Repetitive peak Reverse voltage      | $T_J=25^\circ\text{C}$  | 800 | 1600 | V                      |
| $I_{T(RMS)}$ | RMS on-state current                 | $F=60\text{Hz}, T_c=110^\circ\text{C}$                              | -   | 100  | A                      |
| $I_{TSM}$    | Non-repetitive peak On-state current | $F=50\text{Hz}, t=10\text{ms}$                                      | -   | 1000 | A                      |
|              |                                      | $F=60\text{Hz}, t=8.3\text{ms}$                                     | -   | 1000 | A                      |
| $I^2t$       | $I^2t$ for fusing                    | $T_P=10\text{ms}$   | -   | 4000 | $\text{A}^2\text{S}$   |
| $di/dt$      | Rate of rise of on-state current     | $I_G=2 \times I_{GT}, t_r \leq 100\text{ns}, T_J=125^\circ\text{C}$ | -   | 50   | $\text{A}/\mu\text{s}$ |
| $I_{GM}$     | Peak gate current                    |   | -   | 8.0  | A                      |
| $P_{GM}$     | Peak gate power                      | $T_P=20\mu\text{s}, T_J=125^\circ\text{C}$                          | -   | 10   | W                      |
| $P_{G(AV)}$  | Average gate power                   |   | -   | 2.0  | W                      |
| $T_{STG}$    | Storage temperature                  |   | -40 | 150  | $^\circ\text{C}$       |
| $T_J$        | Junction temperature                 |   | -40 | 125  | $^\circ\text{C}$       |

**Electrical Characteristics**

| Symbol                 | Conditions  | Quadrant              | Numerical  |             |             |             | Unit       |
|------------------------|---|-----------------------|------------|-------------|-------------|-------------|------------|
|                        |   |                       | BTA100-800 | BTA100-1000 | BTA100-1200 | BTA100-1600 |            |
| $V_{TM}$               | $I_T=17A, t_p=380\mu s$                             | $T_J=25^\circ C$ MAX  | 1.3        | 1.3         | 1.3         | 1.55        | V          |
| $I_{DRM}$<br>$I_{RRM}$ | $V_D=V_{DRM}, V_R=V_{RRM}$                          | $T_J=25^\circ C$ MAX  |            |             | 50          |             | $\mu A$    |
|                        |   | $T_J=125^\circ C$ MAX |            |             | 15          |             | mA         |
| $I_{GT}$               | $V_D=12V, R_L=33\Omega$                             | I-II-III    MAX<br>IV |            |             | 50<br>80    |             | mA         |
| $V_{GT}$               |   | I-II-III-IV    MAX    |            |             | 1.5         |             | V          |
| $V_{GD}$               | $V_D=V_{DRM}, R_L=3.3K\Omega,$<br>$T_J=125^\circ C$ | I-II-III-IV    MIN    |            |             | 0.2         |             | V          |
| $I_L$                  | $I_T=1.2I_{GT}$                                     | I-III-IV    MAX       |            |             | 120         |             | mA         |
|                        |   | II    MAX             |            |             | 200         |             | mA         |
| $I_H$                  | $I_T=0.5A$  | MAX                   |            |             | 120         |             | mA         |
| dv/dt                  | $V_{DM}=67\%V_{DRM},$ gate open, $T_J=125^\circ C$  | MIN                   |            |             | 500         |             | V/ $\mu s$ |

**Package Outline Dimensions**


● Typical Characteristics

FIG.1: Maximum power dissipation versus RMS on-state current (full cycle)

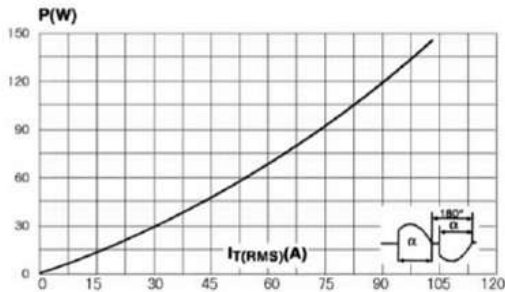


FIG.2: RMS on-state current versus case temperature (full cycle)

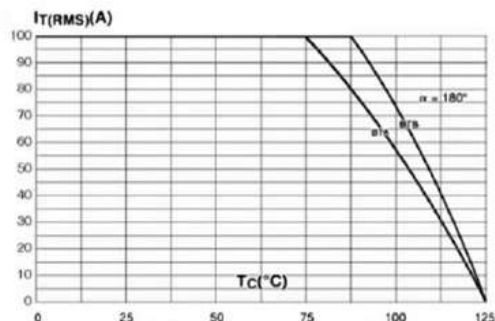


FIG.3: Relative variation of thermal impedance versus pulse duration

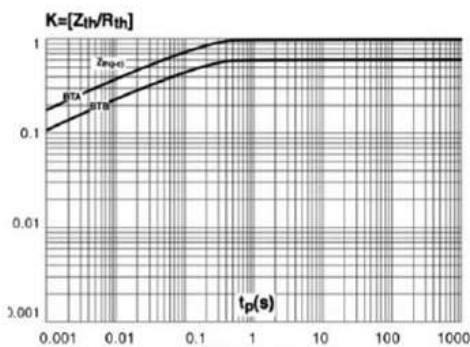


FIG.4: On-state characteristics (maximum values)

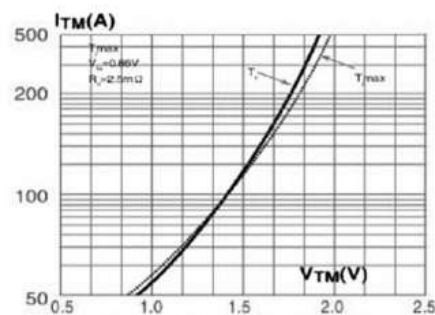


FIG.5: Surge peak on-state current versus number of cycles

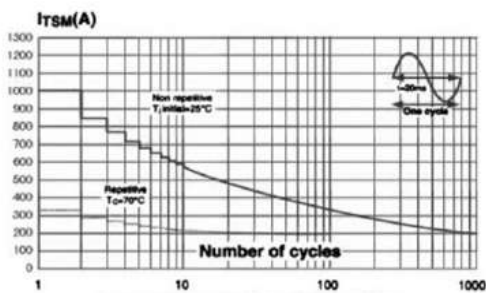


FIG.6: Non-repetitive surge peak on-state current for a sinusoidal pulse with width  $t_p < 10$  ms and corresponding value of  $I^2t$

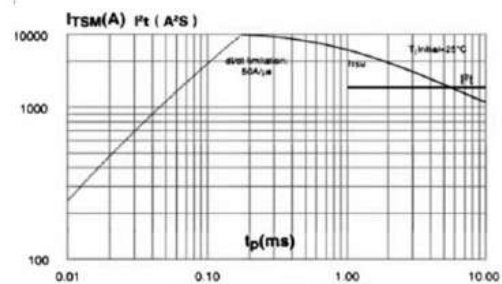


FIG.7: Relative variation of gate trigger current, holding current and latching current versus junction temperature (typical values)

